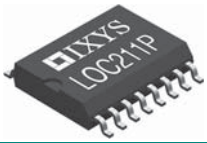
IXYS
INTEGRATED CIRCUITS DIVISION



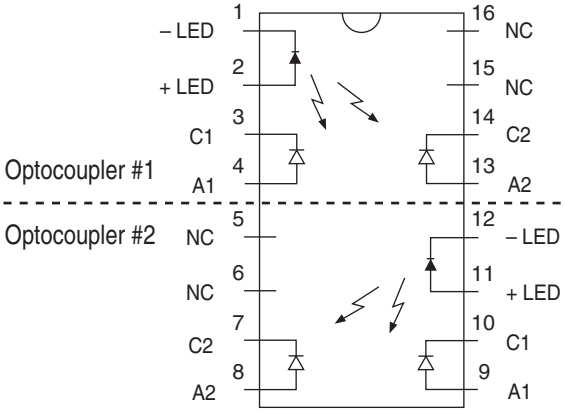
LOC211P
Dual Linear Optocouplers

Parameter	Rating	Units
LED Operating Range	2-10	mA
K3, Transfer Gain	0.773-1.072	-
Isolation, Input to Output	3750	V_{rms}

Features
- 0.01% Servo Linearity
- THD -87dB Typical
- Wide Bandwidth (>200kHz)
- Couples Analog and Digital Signals
- High Gain Stability
- Low Input/Output Capacitance
- Low Power Consumption
- 16-Pin SOIC Package (PCMCIA Compatible)
- Machine Insertable, Wave Solderable
- Surface Mount Tape & Reel Version Available

Applications
- Modem Transformer Replacement With No Insertion Loss
- Digital Telephone Isolation
- Power Supply Feedback Voltage/Current
- Medical Sensor Isolation
- Audio Signal Interfacing
- Isolation of Process Control Transducers

Pin Configuration



Description
The LOC211P Dual Linear Optocoupler features an infrared LED optically coupled with two photodiodes. A feedback (input) photodiode is used to generate a control signal that provides a servomechanism to the LED drive current, thus compensating for the LED's nonlinear time and temperature characteristics. The other (output) photodiode provides an output signal that is linear with respect to the servo LED current. The product features wide bandwidth, high input to output isolation, and excellent servo linearity.

Approvals
- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- Certified to:
  EN 60950-1/A12:2011
  TUV Certificate B 12 11 82667 002

Ordering Information

Part #	Description
LOC211P	16-Pin SOIC (50/tube)
LOC211PTR	16-Pin SOIC (1000/Reel)

K3 Sorted Bins

Bin	K3 Range
Bin 1	0.773 - 0.886
Bin 2	0.887 - 1.072

Bin Matrix

	Top Pole Optocoupler*	Bottom Pole Optocoupler**
Suffix	Bin	
K	1	1
L	1	2
M	2	1
N	2	2

*Top Optocoupler: Pins 1,2,3,4,13, and 14
**Bottom Optocoupler: Pins 7 through 12

Part Number Information
The LOC211P is shipped in anti-static tubes (50 pieces each) or tape/reel (1,000 pieces each). Each container has only 1 bin combination which will be branded on each part with the appropriate bin letter K, L, M, or N in the lower right hand corner. Suffix representation is described in the “Bin Matrix”.

Absolute Maximum Ratings @ 25ºC

Parameter	Ratings	Units
Reverse LED Voltage	5	V
Input Control Current	100	mA
Peak (10ms)	1	A
Input Power Dissipation [1]	150	mW
Power Dissipation Total Package Dissipation [2]	800	mW
Isolation Voltage, Input to Output	3750	V_{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

[1] Derate linearly 1.33 mW / ºC
[2] Derate linearly 6.67 mW / ºC

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

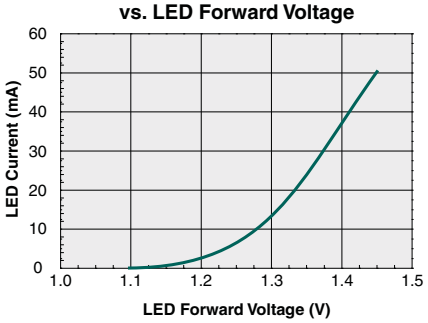
Electrical Characteristics @ 25ºC

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Input Characteristics						
LED Voltage Drop	I_F=2 - 10mA	V_F	0.9	1.2	1.4	V
Reverse LED Current	V_R=5V	I_R	-	-	10	µA
Coupler/Detector Characteristics						
Dark Current	I_F=0mA, V_{C1-A1}=V_{C2-A2}=15V	I_D	-	1	25	nA
K1, Servo Gain (I_{C1}/I_F)	I_F=2 - 10mA, V_{C1-A1}=V_{C2-A2}=15V	K1	0.008	-	0.030	-
K2, Forward Gain (I_{C2}/I_F)		K2	0.006	-	0.030	-
K3, Transfer Gain (K2/K1=I_{C2}/I_{C1})		K3	0.773	-	1.072	-
ΔK3, Transfer Gain Linearity (non-servoed)	I_F=2 - 10mA	ΔK3	-	-	1	%
K3 Temperature Coefficient	I_F=2 - 10mA, V_{C1-A1}=V_{C2-A2}= 5V	ΔK3/ΔT	-	0.005	-	%/°C
Common Mode Rejection Ratio	V=20V_{P-P}, R_L=2kΩ, f=100Hz	CMRR	-	130	-	dB
Total Harmonic Distortion	f_0=350Hz, 0dBm	THD	-96	-87	-80	dB
Frequency Response [2]	Photoconductive Configuration	f_{-3dB}	-	200	-	kHz
	Photovoltaic Configuration		-	40	-	kHz
Common Characteristics						
Input/Output Capacitance	-	$C_{I/O}$	-	3	-	pF

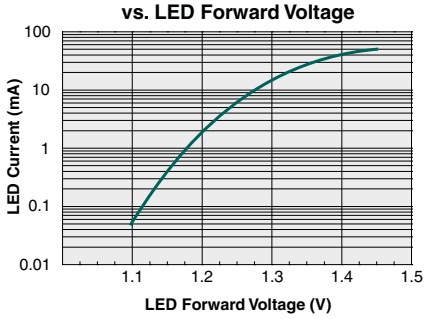
[1] All parameters above are for each optocoupler.
[2] See Application Note, AN-107, for LOC211P configurations.

PERFORMANCE DATA @25ºC (Unless Otherwise Noted)*

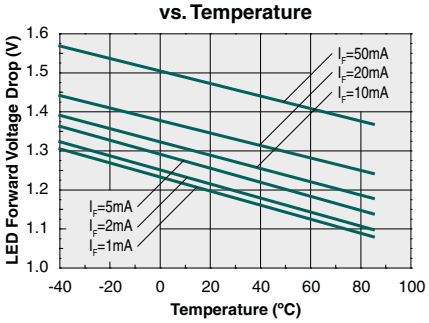
LED Forward Current vs. LED Forward Voltage



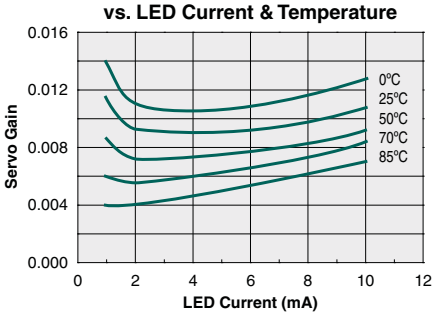
LED Forward Current vs. LED Forward Voltage



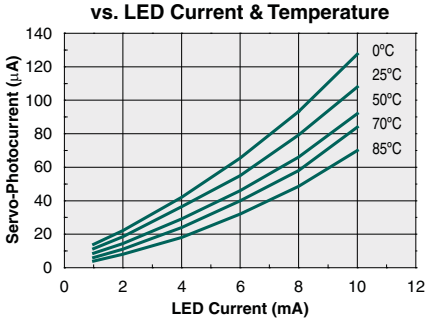
Typical LED Forward Voltage Drop vs. Temperature



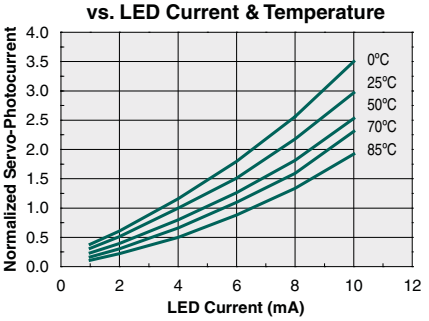
Servo Gain vs. LED Current & Temperature



Servo-Photocurrent vs. LED Current & Temperature



Normalized Servo-Photocurrent vs. LED Current & Temperature



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
LOC211P	MSL 1

ESD Sensitivity

This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

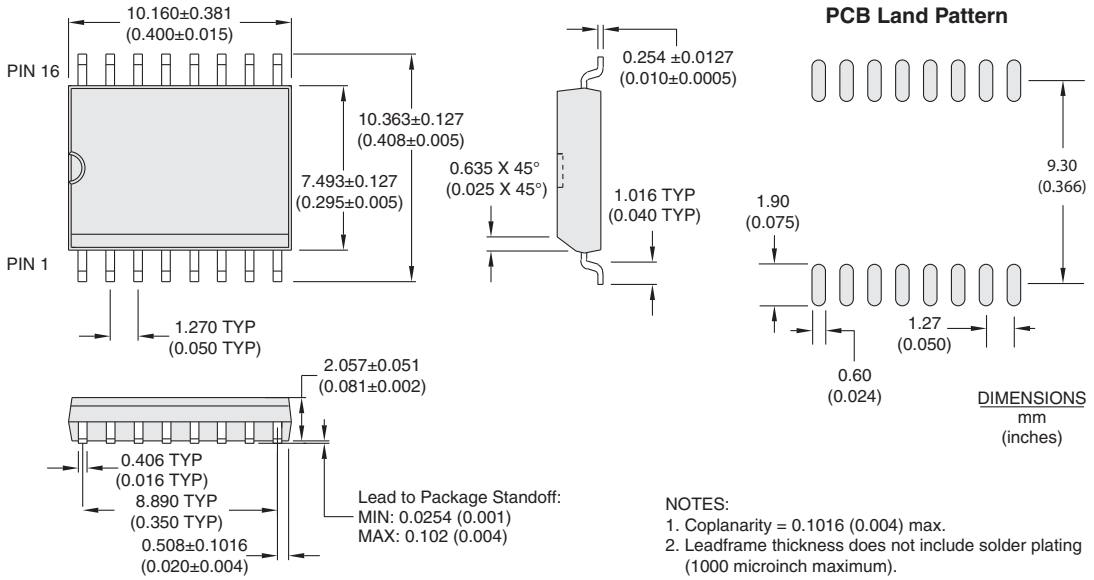
Device	Maximum Temperature x Time
LOC211P	260°C for 30 seconds

Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

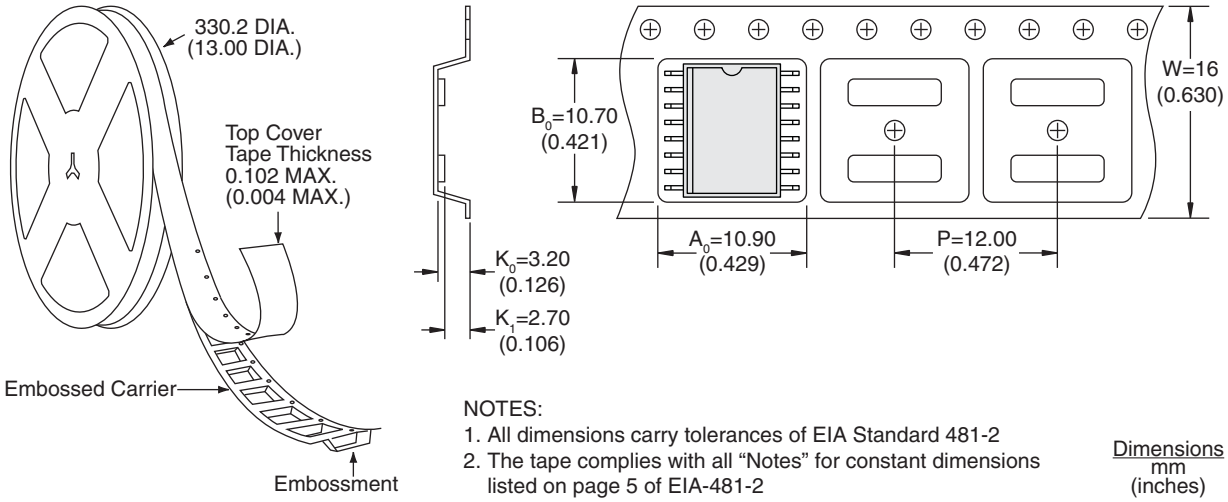
Mechanical Dimensions

LOC211P



NOTES:
1. Coplanarity = 0.1016 (0.004) max.
2. Leadframe thickness does not include solder plating (1000 microinch maximum).

LOC211PTR Tape & Reel



NOTES:
1. All dimensions carry tolerances of EIA Standard 481-2
2. The tape complies with all "Notes" for constant dimensions listed on page 5 of EIA-481-2

Dimensions
mm
(inches)

For additional information please visit our website at: www.ixysic.com

Specification: DS-LOC211P-R06

10/2/2013